

Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- **High Conductance**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound (Note 6). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe) Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)



Top View

Ordering Information (Note 4)

	Part Number	Case	Packaging	
	B0540W-7-F	SOD-123	3,000/Tape & Reel	
Notes:	s: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.			

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/packages.html.

Marking Information



SF = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016)M = Month (ex: 9 = September)

ate Code Key												
Year	2013	2	2014	2015		2016	2017	,	2018	2019	9	2020
Code	А		В	С		D	E		F	G		Н
Mandh	1	F - 1	N4	A			11	A	0	01	Nerr	Dee
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	0	4	5	6	7	0	0	\circ	N	D



Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic	Cumph of	Value	l lmit
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}		
Working Peak Reverse Voltage	V _{RWM}	40	V
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See Figure 4)	lo	0.5	A
Non-Repetitive Peak Forward Surge Current		5.5	٨
8.3ms single half sine-wave superimposed on rated load	IFSM	5.5	A

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Typical Thermal Resistance Junction to Ambient Air (Note 5) $T_A = 25^{\circ}C$	$R_{ hetaJA}$	385	—	°C/W
Typical Thermal Resistance Junction to Ambient Air (Note 6) $T_A = 25^{\circ}C$	$R_{ heta}JA$	325	—	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to) +150	°C

Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Test Conditions
Minimum Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	40	V	$I_R = 20\mu A$
Maximum Forward Voltage Drop	V _{FM}	0.510 0.620 0.460 0.610	v	$\begin{split} I_F &= 0.5A, \ T_J = 25^\circ C \\ I_F &= 1.0A, \ T_J = 25^\circ C \\ I_F &= 0.5A, \ T_J = 100^\circ C \\ I_F &= 1.0A, \ T_J = 100^\circ C \end{split}$
Maximum Leakage Current (Note 7)	1	10 20	μA	$V_R = 20V, T_J = 25^{\circ}C$ $V_R = 40V, T_J = 25^{\circ}C$
Maximum Leakage Gunenic (140Le 7)	IRM	5.0 13	mA	V _R = 20V, T _J = 100°C V _R = 40V, T _J = 100°C
Total Capacitance	CT	170	pF	$f = 1MHz, V_R = 0V DC$

5. FR-4 PCB, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
6. Polymide PCB, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
7. Short duration pulse test used to minimize self-heating effect. Notes:



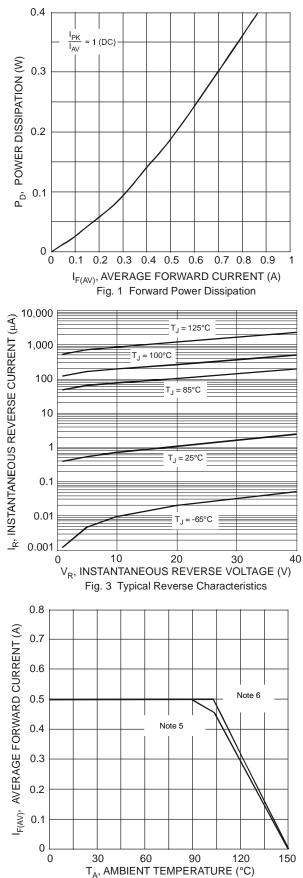
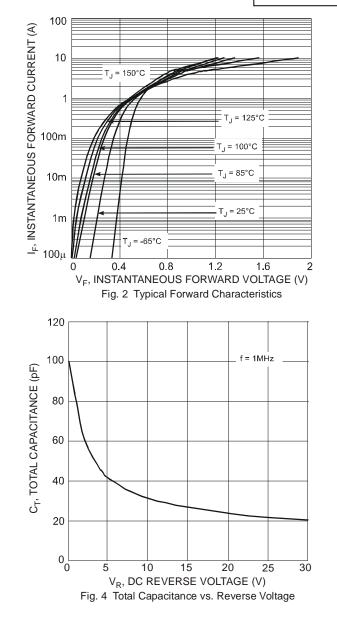


Fig. 5 Forward Current Derating Curve

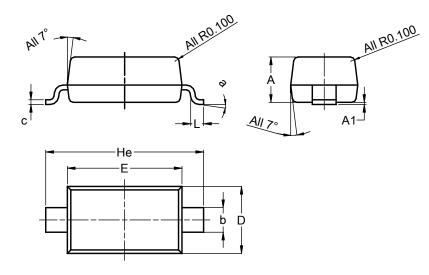




B0540W

Package Outline Dimensions

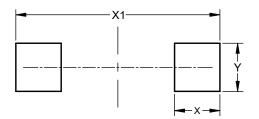
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123						
Dim	Min	Max	Тур			
Α	1.00	1.35	1.05			
A1	0.00	0.10	0.05			
b	0.52	0.62	0.57			
С	0.10	0.15	0.11			
D	1.40	1.70	1.55			
E	2.55	2.85	2.65			
He	3.55	3.85	3.65			
L	0.25	0.40	0.30			
а	0°	8º				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
Х	0.900
X1	4.050
Y	0.950



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